

## P-Channel Enhancement-Mode Power MOS Field-Effect Transistors

August 1991

### Features

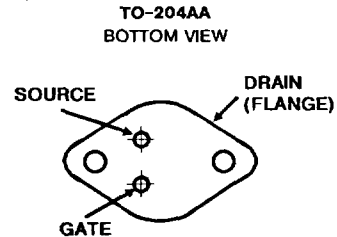
- -12A, -100V
- $r_{DS(on)} = 0.3\Omega$
- SOA is Power-Dissipation Limited
- Nanosecond Switching Speeds
- Linear Transfer Characteristics
- High Input Impedance
- Majority Carrier Device

### Description

The 2N6897 is a P-channel enhancement-mode silicon-gate power MOS field-effect transistor designed for applications such as switching regulators, switching converters, motor drivers, relay drivers, and drivers for high-power bipolar switching transistors requiring high speed and low gate-drive power. This device can be operated directly from an integrated circuit.

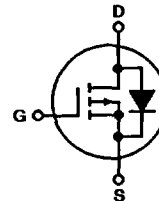
The 2N6897 is supplied in the JEDEC TO-204AA metal package.

### Package



### Terminal Diagram

#### P-CHANNEL ENHANCEMENT MODE



### Absolute Maximum Ratings ( $T_C = +25^\circ\text{C}$ ) Unless Otherwise Specified

|  | 2N6897       | UNITS               |
|--|--------------|---------------------|
| Drain-Source Voltage .....   | -100*        | V                   |
| Drain-Gate Voltage ( $R_{GS} = 1M\Omega$ ) .....                             | -100*        | V                   |
| Continuous Drain Current   |              |                     |
| RMS Continuous .....   | -12*         | A                   |
| Pulsed Drain Current .....   | -30*         | A                   |
| Gate-Source Voltage .....  | $\pm 20^*$   | V                   |
| Maximum Power Dissipation  |              |                     |
| $T_C = +25^\circ\text{C}$ .....  | 100*         | W                   |
| Above $T_C = +25^\circ\text{C}$ , Derate Linearly .....                      | 0.8*         | W/ $^\circ\text{C}$ |
| Operating and Storage Junction Temperature Range .....                       | -55 to +150* | $^\circ\text{C}$    |
| Maximum Lead Temperature for Soldering .....                                 | 260*         | $^\circ\text{C}$    |
| (At distances $\geq \frac{1}{16}$ " (3.17mm) from seating plane for 10s max) |              |                     |

\*JEDEC registered values

**ELECTRICAL CHARACTERISTICS at Case Temperature ( $T_c$ ) = 25°C unless otherwise specified.**

| CHARACTERISTIC                      | TEST CONDITIONS   | LIMITS |       | UNITS         |
|-------------------------------------|---|--------|-------|---------------|
|                                     |   | Min.   | Max.  |               |
| Drain-Source Breakdown Voltage      | $BV_{DSS}$<br>$I_D = 1 \text{ mA}, V_{GS} = 0$                        | -100   | —     | V             |
| Gate Threshold Voltage              | $V_{GS(th)}$<br>$V_{GS} = V_{DS}, I_D = 0.25 \text{ mA}$              | -2     | -4    | V             |
| Zero Gate Voltage Drain Current     | $I_{DSS}$<br>$V_{DS} = -80 \text{ V}$                                 | —      | 1     | $\mu\text{A}$ |
|                                     | $T_C = 125^\circ\text{C}, V_{DS} = -80 \text{ V}$                     | —      | 50    |               |
| Gate-Source Leakage Current         | $I_{GSS}$<br>$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$                  | —      | 100   | nA            |
| Drain-Source On Voltage             | $V_{DS(on)}^a$<br>$I_D = 7.6 \text{ A}, V_{GS} = -10 \text{ V}$       | —      | 2.28  | V             |
|                                     | $I_D = 12 \text{ A}, V_{GS} = -10 \text{ V}$                          | —      | -4.8  |               |
| Static Drain-Source On Resistance   | $r_{DS(on)}^a$<br>$I_D = 7.6 \text{ A}, V_{GS} = -10 \text{ V}$       | —      | 0.3   | $\Omega$      |
|                                     | $T_C = 125^\circ\text{C}, I_D = 7.6 \text{ A}, V_{GS} = 10 \text{ V}$ | —      | 0.465 |               |
| Forward Transconductance            | $g_{fs}^a$<br>$V_{DS} = -10 \text{ V}, I_D = 7.6 \text{ A}$           | 2      | 8     | mho           |
| Input Capacitance                   | $C_{iss}$<br>$V_{DS} = -25 \text{ V}$<br>$V_{GS} = 0 \text{ V}$       | 400    | 1500  | pF            |
| Output Capacitance                  |   | 200    | 700   |               |
| Reverse Transfer Capacitance        | $C_{rss}$<br>$f = 0.1 \text{ MHz}$                                    | 60     | 240   |               |
| Turn-On Delay Time                  | $t_{d(on)}$<br>$V_{DS} = -50 \text{ V}$                               | —      | 60    | ns            |
| Rise Time                           | $t_r$<br>$I_D = 7.6 \text{ A}$  | —      | 175   |               |
| Turn-Off Delay Time                 | $t_{d(off)}$<br>$R_{gen} = R_{gs} = 15 \Omega$                        | —      | 275   |               |
| Fall Time                           | $t_f$<br>$V_{GS} = -10 \text{ V}$                                     | —      | 175   |               |
| Thermal Resistance Junction-to-Case | $R_{\theta JC}$   | —      | 1.25  |               |

**SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS**

| CHARACTERISTIC        | TEST CONDITIONS  | LIMITS |      | UNITS |
|-----------------------|--|--------|------|-------|
|                       |  | Min.   | Max. |       |
| Diode Forward Voltage | $V_{SD}^a$<br>$I_{SD} = 12 \text{ A}$                                | 0.8    | 1.6  | V     |
| Reverse Recovery Time | $t_{rr}$<br>$I_F = 4 \text{ A}, di_F/dt = 100 \text{ A}/\mu\text{s}$ | —      | 500  | ns    |

\*In accordance with JEDEC registration data.

<sup>a</sup>Pulsed: Pulse duration = 300  $\mu\text{s}$  max., duty cycle = 2%

**5**  
**P-CHANNEL**  
**POWER MOSFETS**

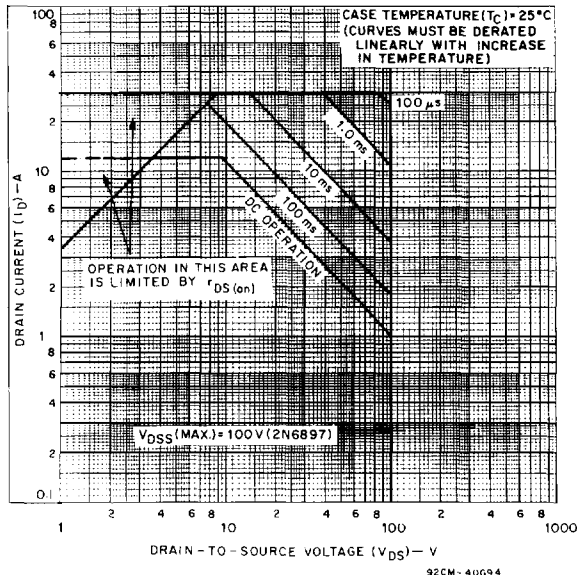


Fig. 1 - Maximum safe operating areas.

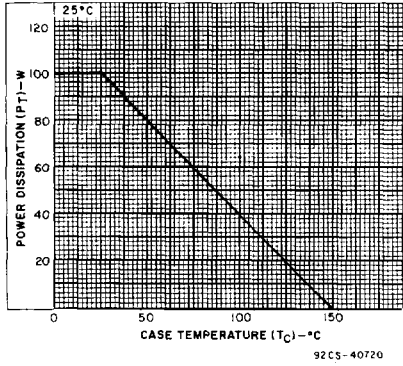


Fig. 2 - Power dissipation vs. temperature derating curve.

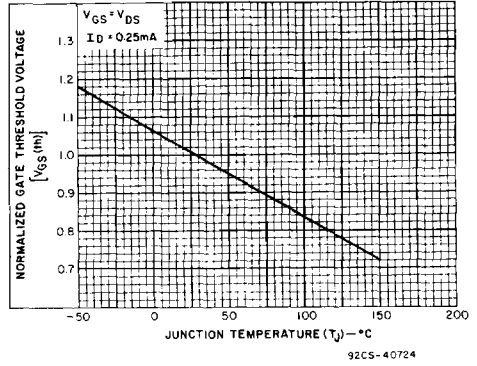


Fig. 3 - Typical normalized gate threshold voltage as a function of junction temperature.

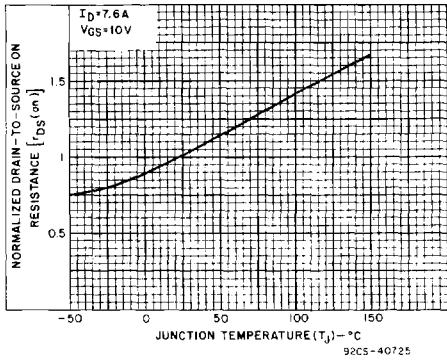


Fig. 4 - Typical normalized drain-to-source on resistance to junction temperature.

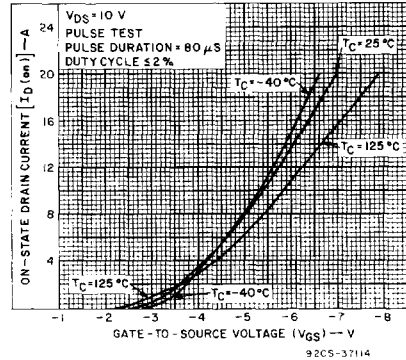


Fig. 5 - Typical transfer characteristics.

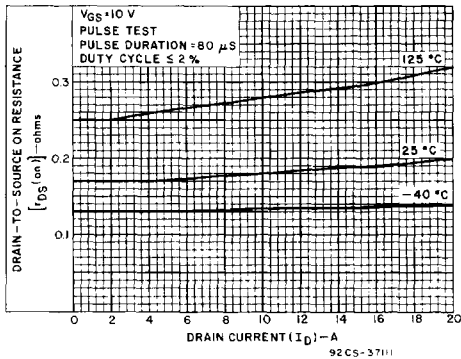


Fig. 6 - Typical drain-to-source on resistance as a function of drain current.

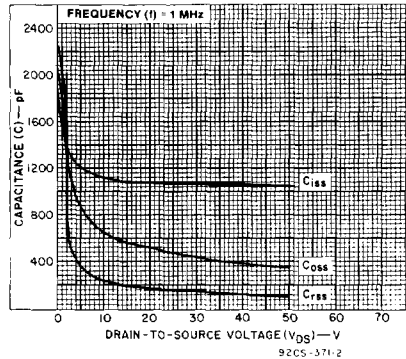


Fig. 7 - Capacitance as a function of drain-to-source voltage.

# 2N6897

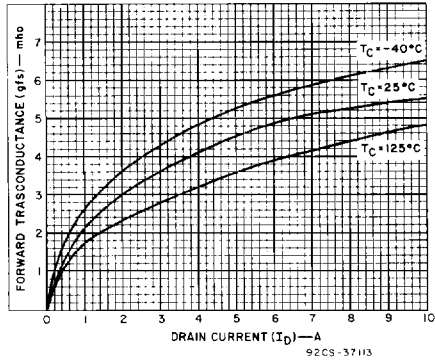


Fig. 8 - Typical forward transconductance as a function of drain current.